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(54) **Schottky barrier semiconductor photodetector.**

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EP 0 252 414 B1

Description

This invention relates to semiconductor photodetectors having Schottky barriers at the electrodes thereof.

A semiconductor photodetector is responsive to incident radiation by a process of converting photons to electron-hole pairs within a layer of semiconductor material thicker than the radiation penetration depth. The resulting electrons and holes are drawn off as electric current between a pair of electrodes located on one or more surfaces of the semiconductor layer. In one form of a semiconductor photodetector of interest, the electrodes are formed as an interdigitated electrode structure, and are biased by an external source of voltage to draw off the electrons and the holes. The electrodes may be constructed of metal joined to the semiconductor material by either ohmic contacts or Schottky barrier contacts.

Of particular interest herein is the photodetector structure employing the Schottky barrier contacts.

The potential barrier of the Schottky construction is desirable for inhibiting the generation of electric current except by photon generated electron-hole pairs. This is useful in the transmission of digital signals optically by radiation such as infra-red and visible light, the optical signals being converted to electric signals by the photodetector. Such transmission may be accomplished by pulses of radiation. The Schottky construction is advantageous in that the foregoing action of the potential barrier inhibits the appearance of noise currents which would increase noise and distort the digital signals.

A problem arises in the foregoing structure wherein elements of the electrodes extend in parallel array across the surface of the semiconductor material. At the edges of the electrodes, intense potential gradients are present which can cause tunneling. The electron and the hole currents induced by the radiation can be entrapped at the surface of the semiconductor material. The entrapped charge carriers alter the profile of the potential fields at the sites of the Schottky barriers to increase the potential gradient even more, narrowing the potential barriers in a direction parallel to the semiconductor surface. In accordance with quantum mechanics, the tunneling of charges through the barriers increases, an effect of the tunneling being the appearance of noise currents in the reception of the foregoing digital signals. The tunneling, therefore, diminishes the advantage of using the Schottky construction in the photodetector.

One aspect of the entrapment of the charge carriers is the fact that the effect of the entrapped

carriers, namely, the alteration of the potential field, changes slowly with time. For example, a pulsed infrared signal incident upon the detector would be converted by the altered potential field to a pulse having a relatively sharp leading edge followed by a slow drift in amplitude. The drift is a result of the slow variation in the disturbance of the potential field by the entrapped charge carriers. This effect may be characterized as an undesirable low frequency gain which alters the waveform of an incoming pulse signal train causing intersymbol interference. Further effects are large dark currents and diminished responsivity of the photodetector and its external circuits to incoming radiation signals.

EP-A-0 063 422 discloses a Schottky barrier photodetector comprising an active layer of photosensitive semiconductor material and a pair of interdigitated electrodes arranged on the surface of said active layer and forming the Schottky barrier therewith. The gaps between the single fingers of the electrodes are filled up with an undoped passivating semiconductor material serving to protect the active layer from air and to provide an low surface recombination interface with the active layer. Schottky barrier photodetectors having a metal/GaAs/Ge structure are known from JP-A-6 156 769 and JP-A-56 111 273.

The invention as claimed is intended to remedy these drawbacks.

The problems are overcome and other advantages are provided by a semiconductor photodetector comprising a layer of semiconducting material for converting radiation incident upon the photodetector into electric charge carriers within the layer. The invention is particularly applicable to semiconductor material formed of compounds of elements of the third and the fifth columns of the periodic table, known as III-V compounds, such as gallium arsenide. In a preferred embodiment of the invention, the layer is composed of semi-insulating gallium arsenide.

The photodetector further comprises a first electrode having an electrically conductive element extending upon a surface of the layer, and a second electrode having an electrically conductive element extending upon the surface of the layer alongside of the element of the first electrode and spaced apart therefrom. Each electrode may have a plurality of elements in which case the electrodes are arranged in an interdigitated format. Each of the electrode elements forms a Schottky barrier with the semiconductor layer for development of an electric current in the presence of the incident radiation and upon connection of a source of bias voltage between the first and the second electrodes.

In accordance with the invention, the entrapment of charge carriers at the surface of the semi-

conductor layer under the influence of the electric fields in the vicinity of each of the electrode elements is inhibited by the construction of a doped semiconductor layer at the surface of the layer in which the conversion takes place between the photons and the electric charge carriers. The doped layer deflects and repulses charge carriers away from the surface, thereby to reduce entrapment of charge carriers along the surface and inhibit tunneling of charge carriers under a Schottky barrier. The doped layer is much thinner than the penetration depth of radiation into the conversion layer so as to permit efficient repulsion of charge carriers from the surface. The concentration of impurity atoms in the thickness of the doped layer is chosen such that the doped layer remains depleted of charge carriers and in a high resistivity state. In most cases this is achieved by limiting the product of the doping density and the square of the layer thickness, in accordance with the following equation, such that

$$N_d d^2 \leq \epsilon E_g / 2q$$

where N_d is the density of the dopant atoms; d is the depth or thickness of the layer; ϵ is the dielectric constant of the semiconductor; E_g is the band-gap energy of the semiconductor; and q is the electron charge.

The foregoing aspects and other features of the invention are explained in the following description, taken in connection with the accompanying drawing wherein:

Fig. 1 is a plan view of a photodetector constructed in accordance with the invention, the view also showing connection of the photodetector with an external electric circuit;

Fig. 2 is a sectional view of the photodetector of Fig. 1 taken along the line 2 - 2;

Fig. 3 shows electric field lines between two electrode elements of the photodetector, and energy level diagrams associated therewith; and Fig. 4 shows an energy level diagram as a function of depth through the photodetector to illustrate operation of a charge repulsion layer of the photodetector.

With reference to Figs. 1 and 2, there is shown a photodetector 10 formed of a block 12 of semiconductor material, and block 12 being divided into two layers, namely, an upper layer 14 and a lower layer 16. A set of interdigitated electrodes 18 is disposed on top of the upper layer 14, the electrodes 18 including an anode electrode 18A connected via a resistor 20 to an anode terminal of a battery 22, and a cathode electrode 18B connected to a cathode terminal of the battery 22. The battery 22 serves as a source of voltage bias for operation of the photodetector 10, the resistor 20 providing a

voltage drop proportional to detector current flowing through the photodetector 10. A differential amplifier 24 has a pair of input terminals connected to opposed terminal of the resistor 20 for providing an output signal on line 26 proportional to the detector current.

In the preferred embodiment of the invention, as depicted in Fig. 1, each of the electrodes 18 is provided with a set of elements 28 which extend transversely across a top surface 30 of the block 12. The elements 28 are parallel to each other and are spaced apart from each other to form the interdigitated structure. The electrodes 18 are formed of a metal such as gold, aluminum or platinum, or of other electrically conducting material such as tungsten-silicide which can be made to form a Schottky contact with the semiconductor.

In the fabrication of the photodetector 10, the block 12 is first prepared, the block 12 comprising semi-insulating semiconductor material suitable for converting photons of radiation into electron-hole pairs. While, in the preferred embodiment of the invention, the block 12 is composed of gallium arsenide, it is to be understood that the invention applies also to other semiconductor material, particularly III-V compounds of elements such as aluminum, indium and antimony. The gallium arsenide of the preferred embodiment is responsive to radiation in the range of frequencies from the infrared to the far red portion of the visible spectrum. The incident radiation is indicated in Fig. 2 by large arrow 32 for incoming light, and a smaller arrow 34 representing light which has entered into the block 12 and has become attenuated therein. The light of arrow 34 is attenuated exponentially with distance into the block 12, and may be regarded, for practical considerations, as been fully attenuated at a penetration depth indicated by a dashed line 36. The penetration depth is approximately two to three times the reciprocal of the extinction coefficient in a mathematical representation of the attenuation of the light.

The construction of the photodetector 10 continues by doping the upper surface 30 of the block 12 to form the upper layer 14 of the bulk material. The rest of the material of the block 12, indicated as lower layer 16, remains in semi-insulating gallium arsenide. The formation of the upper layer 14 can be accomplished by chemical-vapor deposition or ionic implantation of suitable dopant material. Alternatively, if desired, the upper layer 14 can be formed by the process of epitaxial growth upon the lower layer 16. The dopants employed in the doping of the upper layer 14 may be either n-type or p-type dopant. A suitable n-type donor, used in a preferred embodiment of the invention, is silicon. Beryllium may be employed as a p-type acceptor dopant. Germanium can also be used as a dopant,

the type of doping (n or p) depending on the method of doping.

With respect to the physical dimensions of the structure of the photodetector 10, it should be noted that the portrayal of the electrode elements 28 is exaggerated in the height thereof so as to facilitate illustration of the elements 28. A typical value of height (Fig. 2) of the elements 28 is 0.15 micron. A typical value of width of an element 28 is 1.0 micron. A typical value of spacing between edges of successive ones of the elements 28 is 2.0 microns. The upper layer 14 has a depth of 100 nm, typically. The penetration depth indicated by the spacing between the top surface 30 and the line 36 is typically 2.0 microns in the case of infrared radiation incident upon gallium arsenide, this being the case depicted in Fig. 2.

The operation of the photodetector 10 can be explained with reference to the diagrams shown in Figs. 3 and 4.

In Fig. 3, the upper diagram shows two successive ones of the electrode elements 28 located on the surface 30, the view herein corresponding to that of the sectional view of Fig. 2. The upper diagram of Fig. 3 also shows lines 38 of force representing the electric field joining the elements 28 in response to the imposition of a bias voltage by the battery 22. In particular, it is noted that the lines 38 tend to cluster together near the edges of the elements 28, and to spread apart at further distance from the element 28. The clustering together of the lines 38 near the edges of the elements 28, in combination with the subsequent spreading of the lines 38 at distance from the elements 28, indicate a potential gradient and its associated high electric field strength in the vicinity of the edges of the elements 28. Such a field strength pattern, in the absence of the upper layer 14 of the invention, would induce a significant amount of entrapment of charge carriers of the electric current flowing between the electrode elements 28 in the presence of the incident radiation and upon imposition of the voltage of the battery 22. The entrapment of the charge carriers at the surface 30 rather than in the bulk of the material of the block 12 is particularly noticeable in the case of crystalline semiconductor material formed with high purity in which case there is little entrapment in the bulk material with the major portion of the entrapment occurring at the surface 30.

There is an energy band diagram corresponding to each of the lines 38 of force of the electric field. One such diagram is shown in the middle of Fig. 3, the diagram showing energy in the vertical direction and distance along a line 38 in the horizontal direction. By way of example, the energy level diagram in the middle of Fig. 3 is shown in registration with the inner edges of the elements 28

to correspond with the uppermost one of the lines 38, shown at the top of Fig. 3. This energy level diagram corresponds to the situation wherein the value of bias voltage is zero. Herein, the energy level diagram is symmetric with respect to each of the electrode elements 28. In particular, it is noted that there is a barrier having a height, as indicated in Fig. 3, this barrier being the potential barrier provided by a Schottky contact. In the construction of the photodetector 10, the electrodes 18 are formed on the surface 30 in accordance with well-known technology for forming a Schottky barrier between each of the elements 28 and the semiconductor material at the surface 30. Such construction corresponds to the energy diagram illustrated in the middle of Fig. 3. In particular, it is noted that the upper line 40 represents the bottom of a conduction band for electrons. The lower line 42 represents the upper edge of a valence band for holes. The Fermi level lies between the conduction and the valence bands.

The lower graph of Fig. 3 is the energy level diagram for the upper electric-field line 38 in the case wherein the battery 22 is applying a non-zero value of bias voltage. The electrode element 28 (top diagram) on the left side is understood to be provided with a positive potential relative to the electrode element 28 on the right side of Fig. 3, this being indicated by the plus and the minus signs. The bottom diagram of Fig. 3 is shown in two forms, one form being represented by a dashed line and the second form being represented by a solid line. The solid line indicates the energy level diagram which is present in the absence of entrapment of electric charge carriers at the surface 30, this being the energy level diagram present in the operation of the invention. The dashed line shows the effect on the energy level diagram produced by entrapment of the charge carriers, which effect would occur in the construction of a photodetector without implementation of the invention.

The solid trace shows a Schottky barrier with normal width, this width being sufficient to insure that no tunneling takes place. The dashed trace provides the Schottky barrier with a reduced width, which width allows a significant amount of tunneling to take place. Holes, indicated by the letter h and the plus signs migrate towards the right where the potential is more negative, the negative charges, indicated by the letter e and minus signs, migrate towards the left where the potential is more positive. Trapped holes, indicated by the positive signs, are shown towards the right of the energy diagram while trapped electrons, indicated by the minus signs, are shown at the left side of the energy diagram. It is the set of trapped charges which alter the shape of the solid trace to provide the un-

desired dashed trace with its attendant reduced with. at the ends of the energy diagram.

The upper layer 14 (Fig. 2) is sufficiently doped to provide a repulsive force which deflects the charge carriers away from the surface 30 so as to inhibit the entrapment of the charge carriers. Thereby, the holes and the electrons do not collect at the ends of the energy diagram, and the dashed representation of the energy diagram does not appear. Thus, in accordance with the invention, the charge repulsion feature of the upper layer 14 insures that the energy diagram has the shape of the solid trace with its associated normal width to the Schottky barrier. As noted above, the normal width is sufficient to insure no more than an insignificant amount of tunneling through the barrier.

In a preferred embodiment of the invention, sufficient charge repulsion has been attained by doping the upper layer 14 with dopant at a concentration 10^{17} atoms/cubic centimeter. Such a concentration of dopant atoms in a layer on the order of a few microns thick, or thicker, would produce a highly conductive layer. However, in the relatively thin depth of the upper layer 14, 100 nm or less as noted above, the conductivity of the upper layer 14 still remains relatively low, sufficiently low so as to present no significant contribution to the current flow between electrode elements 28. The concentration of charge carriers in the semi-insulating GaAs of the lower layer 16 is on the order of 10^8 atoms/ cubic centimeter, this being nine orders of magnitude less than that of the upper layer 14. The concentration of the dopant atoms is to be increased for thinner values of the upper layer 14, and is to be decreased for thicker values of the upper layer 14, the concentration being inversely proportional to the square of the layer of thickness as is disclosed above in the mathematical equation.

The foregoing effect may be seen in Fig. 4 wherein the conduction and the valence bands are indicated by dashed lines for the case of an undoped upper layer 14, the solid trace showing the shift in energy level for the case of the doping of the upper layer 14. In Fig. 4, the graphs representing the conduction and the valence bands are drawn in registration with the layers 14 and 16 of the photodetector 10. The photodetector 10 is turned sideways in Fig. 4 in order to present the conduction and the valence bands as a function of distance normal to the surface 30 of the photodetector 10. The energy levels of Fig. 4 are drawn for the case of type-n doping wherein the upper layer 14 introduces a potential to the surface 30 which is more negative than the interface between the layers 14 and 16.

Thus, as shown in Fig. 4, at the interface between the layers 14 and 16, there is produced a

potential well towards which the electrons migrate and from which the holes are expelled. Thereby, electrons tend to be driven away from the surface 30 so as to avoid entrapment of the electrons at the surface 30. Also, with respect to the holes, the great majority of the holes is urged into the lower layer 16 while only a relatively small fraction of the holes is driven toward the surface 30. This avoids entrapment of all but a small fraction of holes at the surface 30. The foregoing discussion of the energy levels of Fig. 4 applies also to the implementation of type-p doping in the upper layer 14.

It is interesting to note that, in the event that the upper layer 14 were extended to a greater depth, then the conduction band would approach the Fermi level as is the case is highly conductive material. However, due to the relatively small depth of the upper layer 14, the conduction band remains distant from the Fermi level, in spite of the high concentration of dopant atoms, so as to retain sufficient resistance between the anode electrode 18A and the cathode electrode 18B for proper operation of the photodetector 10. By way of example, in view of the high resistance of a layer of intrinsic, or semi-insulating, semiconductor material, as in the lower layer 16, which resistance might be on the order of many (10 to 40) megohm, a resistance of the upper layer 14 on the order of 0.1 megohm or 1.0 megohm would be adequate resistance for proper operation of the photodetector 10. This is attained with the above-noted depth of 0.1 μm (1000 angstroms) of the upper layer 14.

The foregoing discussion applies to a structure of the electrodes 18 containing any number of the electrode elements 28. The dashed lines appearing in Fig. 1 indicate that the electrode structure may be extended to insert as many electrode elements 28 as may be required. Also the number of electrode elements 28 may be reduced. In the limiting case of only two electrode elements 28, one for the anode electrode 18A and one for the cathode electrode 18B, the foregoing theory of operation still applies.

The structure of the photodetector 10 is readily constructed on a supporting substrate (not shown) which might also support other semiconductor devices in the form of an integrated circuit, such devices including a field-effect transistor such as a GaAs MESFET. For example, such transistors may be constructed of layers of semiconductor material with implantation of dopants in specific regions. The processes employed in the construction of such devices may also employed in the construction of the invention. In particular, it is noted that steps of implantation, such as ionic implantation, are followed by a step of annealing to refurbish the crystalline structure so as to seat the implanted atoms in their proper sites in the crystalline lattice.

While such annealing may tend to increase the tendency for surface entrapment of charged carriers, the thin charge repulsion layer of the invention adequately inhibits such entrapment. Thus, the invention is compatible with the implant annealing step.

Claims

1. A Schottky barrier semiconductor photodetector (10) comprising:
 - a layer (16) of semiconducting material for converting radiation incident upon the photodetector into electric charge carriers within said layer,
 - a first electrode (18A) having an electrically conductive element extending upon a surface (30) of said layer (16);
 - a second electrode (18B) having an electrically conductive element extending upon said surface (30) of said layer (16) alongside of said element of said first electrode (18A) and spaced apart therefrom;
 - each of said electrode elements forming a Schottky barrier with said semiconductor layer (16) for development of an electric current in the presence of the incident radiation and upon connection of a source (22) of bias voltage between said first and said second electrodes (18A, 18B), said photodetector further comprising:
 - means (14) located along said surface for deflecting charge carriers away from said surface, thereby to reduce entrapment of charge carriers of said electric current along said surface and inhibit tunneling of charge carriers under a Schottky barrier;
 - wherein said deflecting means comprises a second layer (14) of semiconductor material formed within said first-mentioned layer (16) of semiconductor material and located at said surface, said second layer (14) extending between said first and said second electrodes (18A, 18B), and said second layer (14) being doped to provide charge carriers with a concentration greater by at least an order of magnitude than the concentration of charge carriers in said first-mentioned layer (16); and wherein said radiation penetrates in said first-mentioned layer (16) to a predetermined penetration depth (36) from said surface defining an active region for said converting; and wherein the depth of said second layer (14) is smaller by at least approximately an order of magnitude than the depth of said active region.
2. A photodetector according to claim 1 wherein said first electrode (18A) comprises further

electrically conductive elements (28), said element and said further elements of said first electrode constituting a first plurality of elements; and wherein said second electrode (18B) comprises further electrically conductive elements (28), said element and said further elements of said second electrode constituting a second plurality of elements, said first plurality of elements being interleaved among said second plurality of - elements and being spaced apart therefrom to form an interdigitated electrode structure.

3. A photodetector according to claim 1 and 2 wherein the material of said first layer (16) is semi-insulating semiconductor material having a relatively high resistivity, the resistance of the active region depending on the depth and resistivity of said active region; the doping of said second layer (14) reducing the resistivity thereof to a value less than the resistivity of said first layer (16), the resistance of said second layer (14) depending on the depth and resistivity of said second layer, the resistance of said second layer being greater than approximately one percent of the resistance of said active region.
4. A photodetector according to claim 3 wherein the resistance of said second layer (14) is greater than approximately one tenth of the resistance of said active region.
5. A photodetector according to claims 1 to 4 wherein each of said electrodes (18) is formed of metal, wherein the semiconductor material of said first and said second layers (16, 14) is semi-insulating gallium-arsenide, and wherein said second layer (14) is doped with silicon as a type n dopant.
6. A photodetector according to claims 1 to 5 wherein each of said electrodes is formed of metal, wherein the semiconductor material of said first and said second layers (16, 14) is semi-insulating gallium-arsenide, and wherein said second layer is doped with beryllium as a type p dopant.
7. Radiation responsive device comprising a Schottky barrier semiconductor photodetector according to claim 1.

Patentansprüche

1. Halbleiterphotodetektor mit Schottky-Sperrschicht (10) mit:
 - einer Schicht (16) aus halbleitendem Material

zum Umwandeln auf den Photodetektor auftretender Strahlung in elektrische Ladungsträger innerhalb der Schicht,

einer ersten Elektrode (18A) mit einem elektrisch leitenden Element, das sich auf eine Oberfläche (30) der Schicht (16) erstreckt, einer zweiten Elektrode (18B) mit einem elektrisch leitenden Element, das sich auf die Oberfläche (30) der Schicht (16) längs des Elementes der ersten Elektrode (18A) und von diesem getrennt erstreckt, wobei jedes der Elektrodenelemente eine Schottky-Sperrschicht mit der Halbleiterschicht (16) zur Erzeugung eines elektrischen Stromes in Gegenwart der auftretenden Strahlung und nach Anschluß einer Vorspannungsquelle (22) zwischen der ersten und der zweiten Elektrode (18A, 18B) bildet und der Photodetektor weiter aufweist:

eine Einrichtung (14), die längs der Oberfläche angeordnet ist, zum Ablenken von Ladungsträgern von der Oberfläche weg, wodurch das Einfangen von Ladungsträgern des elektrischen Stromes längs der Oberfläche verringert und das Tunneln von Ladungsträgern unter eine Schottky-Sperrschicht verhindert wird, wobei die Ablenkeinrichtung eine zweite Schicht (14) aus Halbleitermaterial aufweist, die innerhalb der erstgenannten Schicht (16) aus Halbleitermaterial gebildet und an der Oberfläche gelegen ist, wobei die zweite Schicht (14) sich zwischen der ersten und der zweiten Elektrode (18A, 18B) erstreckt und dotiert ist, um Ladungsträger mit einer gegenüber der Konzentration der Ladungsträger in der erstgenannten Schicht (16) um mindestens eine Größenordnung höheren Konzentration bereitzustellen, und wobei die Strahlung in die zuerst erwähnte Schicht (16) bis auf eine vorbestimmte Eindringtiefe (36) von der Oberfläche eindringt, wodurch ein aktives Gebiet für die Umwandlung bestimmt wird, und wobei die Tiefe der zweiten Schicht (14) um mindestens eine Größenordnung kleiner als die Tiefe des aktiven Gebietes ist.

2. Photodetektor nach Anspruch 1, bei dem die erste Elektrode (18A) weitere elektrisch leitende Elemente (28) aufweist, wobei das Element und die weiteren Elemente der ersten Elektrode eine erste Anzahl von Elementen bilden, und bei dem die zweite Elektrode (18B) weitere elektrisch leitende Elemente (28) aufweist, wobei das Element und die weiteren Elemente der zweiten Elektrode eine zweite Anzahl von Elementen bilden und die erste Anzahl von Elementen mit der zweiten Anzahl von Elementen verzahnt und von dieser getrennt ist,

um eine doppelkammförmige Elektrodenstruktur zu bilden.

3. Photodetektor nach Anspruch 1 und 2, bei dem das Material der ersten Schicht (16) halbisolierendes Halbleitermaterial mit einem relativ hohen spezifischen Widerstand ist, wobei der Widerstand des aktiven Gebietes von der Tiefe und dem spezifischen Widerstand des aktiven Gebietes abhängt, die Dotierung der zweiten Schicht (14) deren spezifischen Widerstand auf einen geringeren Wert als den spezifischen Widerstand der ersten Schicht (16) verringert, der Widerstand der zweiten Schicht (14) von der Tiefe und dem spezifischen Widerstand der zweiten Schicht abhängt und der Widerstand der zweiten Schicht größer als etwa ein Prozent des Widerstandes des aktiven Gebietes ist.
4. Photodetektor nach Anspruch 3, bei dem der Widerstand der zweiten Schicht (14) größer als etwa ein Zehntel des Widerstandes des aktiven Gebietes ist.
5. Photodetektor nach den Ansprüchen 1 bis 4, bei dem jede der Elektroden (18) aus Metall gebildet ist, das Halbleitermaterial der ersten und der zweiten Schicht (16, 14) halbisolierendes Galliumarsenid ist und die zweite Schicht (14) mit Silicium als Dotand vom n-Typ dotiert ist.
6. Photodetektor nach den Ansprüchen 1 bis 5, bei dem jede der Elektroden aus Metall gebildet ist, das Halbleitermaterial der ersten und zweiten Schicht (16, 14) halbisolierendes Galliumarsenid ist und die zweite Schicht mit Beryllium als Dotand vom p-Typ dotiert ist.
7. Strahlungsempfänger mit einem Photodetektor mit Schottky-Sperrschicht nach Anspruch 1.

Revendications

1. Photodétecteur semiconducteur à barrière de Schottky (10), comprenant :
une couche (16) de matière semiconductrice, pour convertir un rayonnement incident sur le photodétecteur en porteurs de charge électrique dans ladite couche ;
une première électrode (18A) ayant un élément électriquement conducteur qui s'étend sur une surface (30) de ladite couche (16) ;
une deuxième électrode (18B) ayant un élément électriquement conducteur qui s'étend sur ladite surface (30) de ladite couche (16) le long dudit élément de la dite première électro-

de (18A) et à une certaine distance de celui-ci ;

chacun desdits éléments d'électrode formant une barrière de Schottky avec ladite couche semiconductrice (16) pour la génération d'un courant électrique en la présence du rayonnement incident et lors de la connexion d'une source (22) de tension de polarisation entre la dite première et ladite deuxième électrodes (18A,18B); ledit photodétecteur comprenant en outre :

des moyens (14) placés le long de ladite surface, pour dévier les porteurs de charge et les éloigner de ladite surface, afin de réduire le piégeage des porteurs de charge dudit courant électrique le long de la dite surface et d'empêcher l'effet tunnel des porteurs de charge sous une barrière de Schottky ;

dans lequel lesdits moyens de déviation comprennent une deuxième couche (14) de matière semiconductrice formée à l'intérieur de ladite couche citée en premier (16) de matière semiconductrice et située à l'endroit de ladite surface, ladite deuxième couche (14) s'étendant entre lesdites première et deuxième électrodes (18A,18B), ladite deuxième couche (14) étant dopée de manière à fournir des porteurs de charge avec une concentration plus grande, d'au moins un ordre de grandeur, que la concentration des porteurs de charge dans ladite couche citée en premier (16) ;

et dans lequel ledit rayonnement pénètre dans ladite couche citée en premier (16) à une profondeur de pénétration prédéterminée (36) par rapport à ladite surface, de façon à définir une région active pour ladite conversion ;

et dans lequel la profondeur de ladite deuxième couche (14) est plus petite, d'au moins environ un ordre de grandeur, que la profondeur de ladite région active.

2. Photodétecteur suivant la revendication 1, dans lequel ladite première électrode (18A) comprend d'autres éléments électriquement conducteurs (28), ledit élément et lesdits autres éléments de ladite première électrode constituant une première pluralité d'éléments ; et dans lequel ladite deuxième électrode (18B) comprend d'autres éléments électriquement conducteurs (28), ledit élément et lesdits autres éléments de ladite deuxième électrode constituant une deuxième pluralité d'éléments, ladite première pluralité d'éléments étant imbriquée parmi ladite deuxième pluralité d'éléments et étant espacée de cette dernière de manière à constituer une structure d'électrodes imbriquées.

3. Photodétecteur suivant les revendications 1 et 2, dans lequel la matière de ladite première couche (16) est une matière semiconductrice et semi-isolante ayant une résistivité relativement élevée, la résistance de la région active dépendant de la profondeur et de la résistivité de ladite région active ; le dopage de la dite deuxième couche (14) réduisant sa résistivité à une valeur inférieure à la résistivité de ladite première couche (16), la résistance de ladite deuxième couche (14) dépendant de la profondeur et de la résistivité de ladite deuxième couche, la résistance de ladite deuxième couche étant supérieure à 1% environ de la résistance de ladite région active.

4. Photodétecteur suivant la revendication 3, dans lequel la résistance de ladite deuxième couche (14) est supérieure à un dixième environ de la résistance de la dite région active.

5. Photodétecteur suivant les revendications 1 à 4, dans lequel chacune desdites électrodes (18) est constituée de métal ; dans lequel la matière semiconductrice desdites première et deuxième couches (16,14) est de l'arséniure de gallium semi-isolant ; et dans lequel la dite deuxième couche (14) est dopée avec du silicium comme dopant de type n.

6. Photodétecteur suivant les revendications 1 à 5, dans lequel chacune desdites électrodes est constituée de métal ; dans lequel la matière semiconductrice desdites première et deuxième couches (16,14) est de l'arséniure de gallium semi-isolant ; et dans lequel ladite deuxième couche est dopée avec du béryllium comme dopant de type p.

7. Dispositif sensible au rayonnement, comprenant un photodétecteur semiconducteur à barrière de Schottky suivant la revendication 1.

FIG. 1.

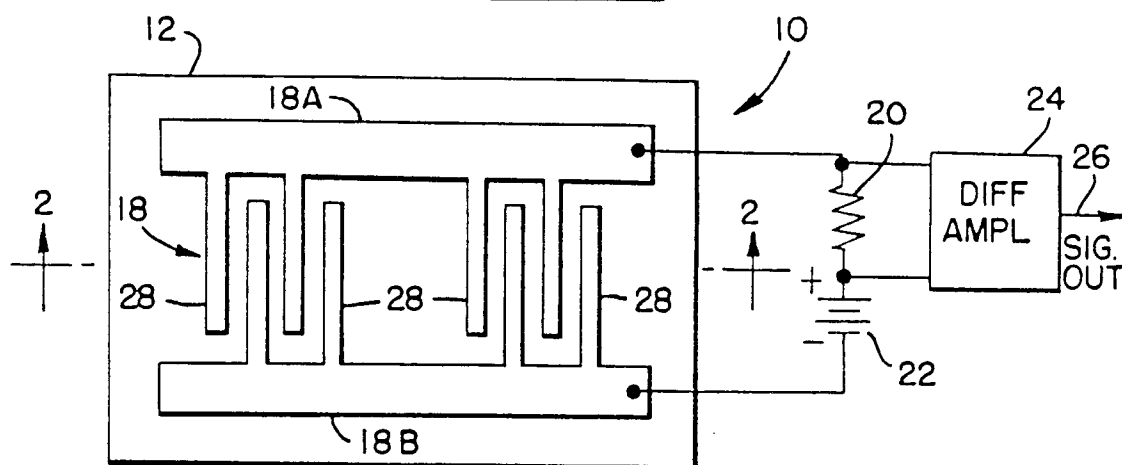


FIG. 2.

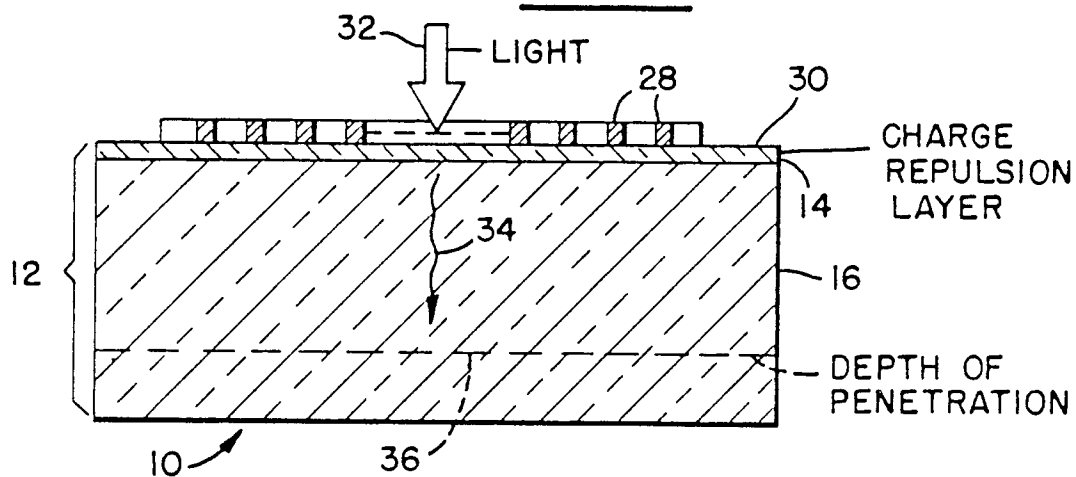


FIG. 4.

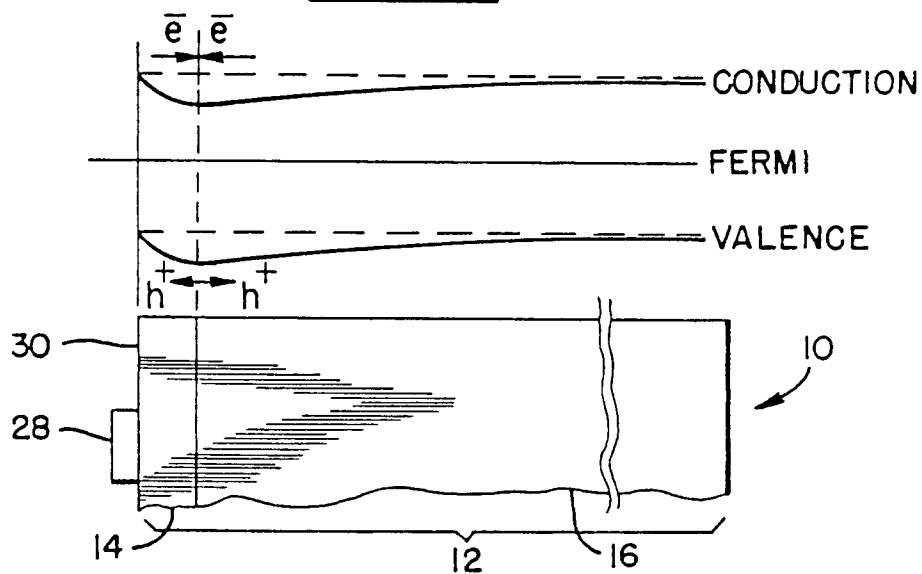


FIG. 3.

